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(54) **ELECTRODES DE GRANDE SUPERFICIE COMPOSEES DE
NITRURES, DE CARBURES ET DE BORURES ET
TECHNIQUE DE FABRICATION**

(54) **HIGH SURFACE AREA NITRIDE, CARBIDE AND BORIDE
ELECTRODES AND METHODS OF FABRICATION THEREOF**

(57) Electrodes de grande superficie destinées à des appareils de stockage et de transformation d'énergie électrique et électrochimique, composées de nitrures, de carbures et de borures de molybdène ou de tungstène, métaux de transition conducteurs. Est présentée une technique de fabrication de telles électrodes par formation ou dépôt d'une couche d'oxyde métallique, puis par exposition de cette couche, à température élevée, à une source d'azote, de carbone ou de bore, dans un milieu chimiquement réducteur, en vue d'obtenir la pellicule de nitrure, de carbure ou de borure souhaitée. Est également présenté un supercondensateur muni des nouvelles électrodes de grande superficie, ayant une capacité spécifique de 100 mF/cm^2 et une densité d'énergie de 100 mJ/cm^3 et possédant une conductivité et une stabilité chimique améliorées par rapport aux électrodes actuellement disponibles.

(57) High surface area electrodes for use in electrical and electrochemical energy storage and conversion devices comprise conductive transition metal nitrides, carbides, borides or combinations thereof where the metal is molybdenum or tungsten. Disclosed is a method of manufacturing such electrodes by forming or depositing a layer of metal oxide, then exposing the metal oxide layer at elevated temperature to a source of nitrogen, carbon or boron in a chemically reducing environment to form the desired metal nitride, carbide or boride film. Also disclosed is an ultracapacitor comprised of the new high surface area electrodes having a specific capacitance of 100 mF/cm^2 and an energy density of 100 mJ/cm^3 with improved conductivity and chemical stability when compared to currently available electrodes.

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(54) Title: HIGH SURFACE AREA NITRIDE, CARBIDE AND BORIDE ELECTRODES AND METHODS OF FABRICATION THEREOF		
(57) Abstract High surface area electrodes for use in electrical and electrochemical energy storage and conversion devices comprise conductive transition metal nitrides, carbides, borides or combinations thereof where the metal is molybdenum or tungsten. Disclosed is a method of manufacturing such electrodes by forming or depositing a layer of metal oxide, then exposing the metal oxide layer at elevated temperature to a source of nitrogen, carbon or boron in a chemically reducing environment to form the desired metal nitride, carbide or boride film. Also disclosed is an ultracapacitor comprised of the new high surface area electrodes having a specific capacitance of 100 mF/cm² and an energy density of 100 mJ/cm³ with improved conductivity and chemical stability when compared to currently available electrodes. <pre> graph TD A[ADD PRECURSOR TO SOLVENT] --> B[APPLY TO SUBSTRATE] B --> C[DRY] C --> D[CALCINE TO FORM OXIDE] D --> E[REACT TO FORM NITRIDE, CARBIDE AND/OR BORIDE] E --> F[PASSIVATE] </pre>		

HIGH SURFACE AREA NITRIDE, CARBIDE AND BORIDE ELECTRODES AND METHODS OF FABRICATION THEREOF

Background - Field of the Invention.

This invention relates generally to capacitors, batteries, fuel cells,
5 electrochemical synthesis reactors, sensors and other energy
storage/conversion devices, and more particularly to electrodes for use in such
devices.

Background - Discussion of Prior Art.

Electrodes are key elements in several classes of energy storage and
10 conversion devices, including for example, batteries, fuel cells, and capacitors.
Technological advances in the electronics industry have created a substantial
and on-going need to reduce electrode volume and weight to attain increased
electrical and electrochemical energy and power densities. In general,
advances in miniaturization and weight reduction of energy storage devices
15 have not kept pace with the miniaturization and portability of other electronic
components.

Electrical and electrochemical energy storage and peak power generally
scale with the available surface area of the electrode. Hence, a route to
increasing the ratio of stored energy and peak power to the weight and
20 volume of the electrodes is to increase the surface area of the electrodes.

Prior art teaches numerous ways to produce materials with high specific
areas (surface area divided by the mass or volume of the bulk material). U.S.
Pat. No. 4,515,763 and U.S. Pat. No. 4,851,206 teach the preparation of such
materials as metallic carbide and nitride powder catalysts. These patents,
25 however, do not teach conductivity or stability in electrolytic solutions or the
application of these powder catalysts to electrodes.

Prior art identifies three basic types of high surface area electrodes.
One type consists of metallic bodies which are mechanically or chemically
etched to provide a roughened surface and high specific surface area. High
30 surface area electrodes based on etched or patterned metal surfaces are cited
in U.S. Pat. No. 5,062,025. A second type of high surface area electrode is
based on carbon powders or foams, as cited in U.S. Pat. No. 5,079,674 and
U.S. Pat. No. 4,327,400. The third class of high surface area electrodes is

based on conductive metal oxides, e.g. ruthenium oxides, as taught by U.S. Pat. No. 5,185,679. While each of these types of electrodes are the basis of commercial electrical or electrochemical energy storage and conversion devices, they are lacking in performance with respect to one or more of the
5 criteria listed in the Summary below.

Specifically, currently available high surface area metal electrodes are limited by electrochemical stability. Metals are generally unstable in oxidizing environments, therefore their use is limited to the positive, reducing electrode or anode.

10 High surface area carbon electrodes are limited by their relatively low electrical conductivity and difficulty in controlling the pore size distribution and surface area. Most high surface area carbon-based electrodes are formed by dispersing and bonding the carbon materials onto more highly conductive supports or substrates. These multi-step processes require the use of
15 dispersants, binders and conductivity enhancing additives.

High surface area ruthenium oxide based electrodes are also limited by electrochemical stability and by the cost and availability of the electrode materials. Prior art has shown that additives can be used to stabilize the high surface area of the ruthenium oxide when used as the negative, oxidizing
20 electrode or cathode. Unfortunately, ruthenium oxide, and metal oxides in general cannot be stabilized for use as the positive, reducing electrode, or anode. These materials are limited to positive electrical potentials of the order of 1.2 volts, beyond which electrochemical reactions occur, resulting in the irreversible degradation of the electrode materials.

25 **Summary Of The Invention.**

For use as electrodes, additional chemical and physical properties are desired. The electrode material must be substantially and highly electrically conductive, with the possible exception of a thin dielectric or passivating layer on the exposed surfaces. The high surface area electrode material must also
30 be chemically and physically stable under a range of processing and operating environments. Specifically, the electrode material must retain its high surface area and pore size distribution in the presence of the ion-mobile electrolytes typically used in electrical and electrochemical energy storage and conversion

devices. Furthermore, it is desirable that the electrode material retain these desirable properties under a range of positive and negative electrical potentials which may occur, by design or unintentionally, during the operation of the energy storage and conversion devices. In addition to having high surface area, high electrical conductivity, and physical/chemical stability, the electrode materials should be easily wetted by the ion-mobile electrolyte, should be amenable to existing manufacturing processes and production equipment, and should be assembled from inexpensive, widely available, and environmentally acceptable materials.

10 The present invention provides a new type of high surface area electrode for use in electrical and electrochemical energy storage and conversion devices. The electrode comprises conductive transition metal nitrides, carbides, borides or combinations thereof, where the metal is typically molybdenum or tungsten.

15 In another embodiment there is provided a method of manufacturing the electrode of this invention, comprising forming or depositing a layer of metal oxide where the metal is typically molybdenum or tungsten, then exposing the metal oxide layer at elevated temperature to a source of nitrogen, carbon, or boron in a chemically reducing environment to form the desired
20 metal nitride, carbide or boride film. With careful control of the exposure conditions, the nitridation, carburization, or boridation chemical reaction can lead to greatly enhanced specific surface areas relative to the film precursors. Nitrogen, carbon and boron sources are typically ammonia, methane, and diborane, respectively.

25 In another embodiment there is provided an ultracapacitor device comprised of the subject high surface area electrodes having a specific capacitance of 100 mF/cm^2 and an energy density of 100 mJ/cm^3 with improved conductivity and chemical stability when compared to currently available electrodes.

30 **Brief Description Of The Drawings.**

FIG. 1 is a block flow diagram illustrating method steps for fabricating the high surface area electrodes.

FIG. 2 is an example of the temperature program used to convert an oxide film to a high surface area electrode.

FIG. 3 is a block flow diagram illustrating other method steps for fabricating the high surface area electrodes.

5 FIG. 4 is a schematic and enlarged illustration of a capacitor in accordance with the invention.

FIG. 5 is a scanning electron micrograph of an oxide film prior to nitridation, carburization and/or boridation at a magnification of 1,000X.

10 FIG. 6 is a scanning electron micrograph of a film after nitridation, carburization and/or boridation at a magnification of 8,000X.

Description Of The Preferred Embodiments.

High specific surface area nitrides, carbides and borides are produced by reacting a precursor with a source of nitrogen, carbon or boron at an elevated temperature, or by interconverting the nitride, carbide or boride by
15 reaction with an appropriate source of nitrogen, carbon or boron.

Referring to FIG. 1, metal oxide or soluble precursors are mixed into an appropriate solvent in the desired concentrations. Suitable compounds are materials such as water soluble salts, organometallic complexes and alkoxides of metals such as chromium, molybdenum, tungsten, vanadium, niobium,
20 tantalum, titanium and zirconium. These metals and others are selected from Groups III, IV, V, VI and VII of the Periodic Table. The solution is applied by dip coating or spray deposition to a substrate. Other deposition methods such as physical vapor deposition (evaporative coating) or plasma arc spraying may be selected. Suitable substrates are materials like titanium, zirconium,
25 tantalum, molybdenum, tungsten and ruthenium oxide. These metals and others are selected from Groups IV, V, VI, VII and VIII of the Periodic Table. Once the precursor solution has been applied to the substrate, the material is dried at an appropriate temperature.

The dried material is chemically converted to the oxides by reacting
30 with an oxidizing agent. Alternately, the surface of an appropriate substrate material can be oxidized by reaction with a suitable oxidizing agent or an oxide film can be deposited from the vapor phase onto the substrate. Suitable

oxidizing agents are materials such as oxygen, water, nitrogen oxides, and carbon oxides.

The oxide film is chemically converted to the nitride, carbide and/or boride by reacting with a reductant as the temperature is increased in a controlled manner. The rate of increase in the temperature may be linear (0° K/hr to 500° K/hr), for example as illustrated in FIG. 2, or nonlinear but should be uniform without sudden changes in rate. Suitable reductants include ammonia, hydrazine, nitrogen, methyl amine, methane, ethane, borane and diborane. The reaction should be rapidly quenched after completion or held at the final reaction temperature (500° K to 1300°K) for a period of time then quenched to room temperature. Hydrogen and/or inert gas may be added to assist the conversion. The thickness of the nitride, carbide and/or boride film determines the final surface area or capacitance. Capacitance generally scales with film thickness; however, with sufficient increase in thickness, the capacitance eventually approaches an asymptotic limit.

Referring to FIG. 3, a high surface area nitride film produced using methods illustrated in FIG. 1 may be converted into the carbide or boride. The nitride is chemically converted to the carbide and/or boride by reacting with a suitable reactant such as methyl amine, methane, ethane, borane and/or diborane. The reaction may be carried out isothermally or in a temperature programmed manner. After completion, the reaction should be rapidly quenched or held at the final reaction temperature for a period of time then quenched to room temperature. Hydrogen and/or inert gas may be added to assist the conversion. The thickness of the carbide and/or boride film determines the final surface area or capacitance.

The nitride intermediate step followed by conversion to carbide or boride appears to provide better properties for an ultracapacitor; however, direct conversion from oxide to carbide or boride can be accomplished with a suitable reductant as noted above.

The high surface area nitride, carbide and/or boride film may be passivated by exposing the materials to a dilute mixture of an oxidizing agent for a short period of time.

In order to better understand the structure of the capacitor, we refer now to an enlarged view of a portion of the device in FIG. 4. A separator xx is applied to a high surface area electrode zz. A second electrode yy is used to sandwich the separator xx. The first and second electrodes do not have to
5 be made of the same materials. For example, one electrode may be a high surface area nitride, carbide and/or boride while the other is a ruthenium oxide-based material. The oxide-based electrode material may be an oxide formed on a base metal surface or foil. The sandwich is impregnated with an ion-mobile electrolyte solution. Suitable electrolytes include aqueous sulfuric
10 acid, a solution of lithium perchlorate in propylene carbonate or a solution of tetrabutyl ammonium fluoride in acetonitrile. Special care must be taken to dry the non-aqueous electrolytes. Residual water can be removed from the impregnated sandwich by electrolysis (applying a positive potential of 2-4 V).

An alternative capacitor can be fabricated by using a solid electrolyte
15 in place of the liquid electrolyte and separator. The solid electrolyte must be infiltrated or diffused into the pore structure of the high surface area electrodes.

Variations in the construction of the electrode and devices described herein, while not described in detail, will be obvious to those with ordinary
20 skill in the art, and would not be construed as being beyond the scope of the invention. For example, one practiced in the state of the art for electrochemistry will also perceive that variations of the electrode materials described herein may have advantageous applications in fuel cells, electrochemical synthesis reactors, catalysts, and sensors.

25

EXAMPLES

The following test examples are offered by way of example and not by way of limitation.

The molybdenum oxide films were deposited onto high purity Ti (99.7% 0.0127 mm, Aldrich) Mo (99.9% 0.025 mm, Aldrich) foils. The foils
30 were cleaned prior to depositing the oxide in order to remove any organic residue or surface oxides. The Ti foils were cleaned at room temperature using a 2:1 mixture of 12 M nitric acid and 50% hydrofluoric acid. The foil substrates were immersed in the acid solution until red fumes evolved at

which time the substrate was removed and rinsed with copious amounts of distilled water. The Mo foils were cleaned by immersion in an aqueous 18 M sulfuric acid bath at $\sim 75^{\circ}\text{C}$. The foil cleaning procedures were adapted from methods described in the *Metal Finishing Guidebook and Directory* (1993). After a period of 15 minutes or until a water-break-free surface was obtained, the foils were removed from the acid bath and then rinsed with distilled water. After cleaning, the substrates were placed immediately in the coating solution in order to minimize oxidation prior to deposition.

Aqueous solutions of ammonium paramolybdate, $(\text{NH}_4)_6\text{Mo}_7\text{O}_{24} \cdot 4\text{H}_2\text{O}$ (99.999%), Johnson Matthey), were used to deposit the molybdenum oxide coatings. After an appropriate amount of the salt was dissolved in distilled water, the solutions were acidified with 10% nitric acid. The coating solutions were initially stirred using the substrate to ensure that the solution concentrations were uniform. The substrates were suspended at least one centimeter below the liquid surface for 5 minutes. The substrates were then drawn out of the solution at a draw rate of 1 s/cm. The coated substrates were dried on a hot plate (the temperature was less than 90°C) prior to calcination.

The molybdate coatings were converted into MoO_3 by calcination in stagnant air for 30 minutes at temperatures less than 550°C .

Temperature programmed nitridation of the MoO_3 films was carried out in a specially designed reactor. This reactor was constructed from a one inch diameter quartz tube and fitted with a water jacket to cool the effluent gases. The calcined substrates were placed on a firebrick inside the reactor which was placed in a Lindberg SB tube furnace. The temperature was controlled using an Omega CN2010 programmable temperature controller with a chromel-alumel thermocouple. High purity NH_3 (99.99%, Matheson) was used for nitridation. Referring to FIG. 2, the reaction temperature was quickly increased from room temperature to 350°C over 30 minutes. Two linear heating segments were employed in nitriding the oxide films. The temperature was increased from 350 to 450°C at rate β_1 then from 450 to 700°C at a rate β_2 . Subsequently, the temperature was held constant at 700°C for one hour. After the nitridation program was completed, the

materials were cooled to room temperature in flowing NH_3 , then passivated in a flowing mixture of 1.06% O_2 in He for one hour in order to prevent bulk oxidation. The gas flow rates were monitored using a calibrated rotameter and controlled by needle valves.

5 The MoO_3 films supported on Mo substrates possessed porous microstructures and consisted of plate-like particles averaging $2\mu\text{m}$ in thickness and $10\mu\text{m}$ in diameter (see FIG. 5). The MoO_3 supported on Ti substrates was also porous but consisted of very fine grains approximately $2\mu\text{m}$ in diameter. The gross morphologies of the nitrated films were similar to those of the
10 oxides, however, the nitride particles contained very fine cracks (see FIG. 6). The development of cracks would lead to the exposure of internal surface area and production of high surface area materials. Finally, it was observed that there was much less surface charging during scanning electron micrography (SEM) for the nitride films than for the oxide films, which is consistent with the
15 nitride films being electrically conductive.

 The weights and BET (Brunauer, Emmett and Teller) surface areas of the Mo nitride films increased with each dip. The materials listed in Table 1 were prepared via the temperature programmed nitridation of MoO_3 films in flowing NH_3 ($100\text{ cm}^3/\text{min}$) using first and second heating rates of 40 and $200^\circ\text{C}/\text{h}$,
20 respectively. The choice of substrate had a marked effect on the weight of $\gamma\text{-Mo}_2\text{N}$ generated. The weights and surface areas of the nitride films supported on Mo substrates were generally higher than those of the films supported on Ti substrates. The surface area increased nearly linearly with film weight for both substrates indicating that the specific surface area was not a strong
25 function of the substrate employed. There was no evidence of delamination, occlusion or consolidation. These observations suggested that the films were porous and that the nitride surface area per unit substrate area can be increased by increasing the coating mass and thickness.

Table 1. Weights and Surface Areas of the Mo Nitride Films

Sample	Weight (mg)	Surface Area (cm ² /cm ²)	Specific Surface Area (m ² /gr)
Mo-5.0-0.2-1-1	1.3	735	57
Mo-5.0-0.2-1-2	2.7	1469	54
Mo-5.0-0.2-1-4	4.7	3131	67
Ti-5.0-0.2-1-1	0.5	88	18
Ti-5.0-0.2-1-2	0.5	346	59
Ti-5.0-0.2-1-4	2.8	1037	37

The surface areas were functions of the heating rates and flow rate employed during nitridation. Effects of the nitridation conditions on the surface areas of the Mo nitride films can be deduced from the results given in Table 2. When the nitridation program with β_1 and β_2 equal to 100 and 200°C/h, respectively, was employed, the surface area decreased as the flow rate was increased. A similar behavior was observed when both of the heating rates were 100°C/hr. The opposite effect was observed when the heating schedule with β_1 and β_2 equal 40 and 200°C/h, respectively, was used.

Effects of similar magnitude were observed on varying the first heating rate β_1 . When the nitridation was carried out using the low flow rate (100 cm³/min), increasing β_1 caused a decrease in the surface area. For films prepared using the high flow rate (1000 cm³/min), increasing β_1 caused an increase in the surface area. The most significant changes were observed when the second heating rate was varied. Increasing β_2 caused a marked decrease in the surface area. Furthermore, surface areas in excess of 70 m²/gr were achieved using the low value for β_2 .

**Table 2. Effects of the Nitridation Conditions
on the Mo Nitride Surface Areas**

Sample	β_1 (°C/hr)	β_2 (°C/hr)	Q_{NH_3} (cm ³ /min)	Surface Area (cm ² /cm ²)	Specific Surface Area (m ² /gr)
Mo-5.0-0.2-1-2A	100	200	1000	3574	44
5 Mo-5.0-0.2-1-2B	100	200	100	1868	37
Mo-5.0-0.2-1-2C	100	100	1000	2213	105
Mo-5.0-0.2-1-2D	100	100	100	1314	73
Mo-5.0-0.2-1-2E	40	200	1000	1970	35
Mo-5.0-0.2-1-2F	40	200	100	1469	54

- 10 The capacitor test cell consisted of a 100 ml round-bottom flask with a tapered ground-glass joint. A rubber stopper with holes for the leads was used to seal off the flask. Either 2.39 M LiClO₄ (99.99%, Aldrich) in propylene carbonate (99% anhydrous, Johnson Matthey) or 4.18 M H₂SO₄ in distilled water was used as the electrolyte. The cell containing the perchlorate
- 15 solution was assembled in a N₂-filled glovebox to avoid exposure to moisture. Electrical measurements using the H₂SO₄ solution were carried out in ambient air. Fisherbrand P8, coarse porosity filter paper was used to separate the electrodes in the perchlorate solution while Fisherbrand glass fiber circles (coarse porosity) were used for the acid solution. The capacitor was fabricated
- 20 by placing a separator between two electrodes and clamping them together with an alligator clip to secure the assembly. Additional shielded alligator clips were used to connect the foil leads to the voltage source and the coulometer. The cells were charged with a constant voltage source supplied by 1.5 Vdc batteries used separately or in a series of four to obtain voltages
- 25 greater than 6 Vdc. The total charge capacity was measured while allowing the capacitor cell to fully discharge. The capacitance was taken as the total charge stored divided by the charging voltage. The total charge stored by the capacitor was measured using an EG&G 279[®]A coulometer, which was calibrated against two commercial capacitors.

Tables 3 and 4 summarize effects of the film properties, electrolyte composition, and charging voltage on the electrical performance of the test capacitors. Charging times between 1 and 10 minutes were used and the specific capacitance is based on the superficial area of the substrate ($\approx 1 \text{ cm}^2$).

- 5 The capacitances of the cells fabricated from the nitride films were much greater than those of blank cells assembled using uncoated metal substrates. This clearly indicated that the capacitance was due to the presence of the nitride film. Furthermore, the electrical properties were reproducible through several charge/discharge cycles suggesting that the films were stable even at
10 voltages greater than 6V.

In every case, the capacitors fabricated using the Mo substrates had higher capacitances than those consisting of the Ti substrates. The choice of electrolyte also played a major role in determining the charge storage capacity. The specific capacitances achieved using the H_2SO_4 electrolyte approached 1
15 F/cm^2 while those for the LiClO_4 electrolyte ranged from 0.02 to 0.14 F/cm^2 .

The capacitance increased linearly with the surface area of the Mo nitride film for the cell using H_2SO_4 as the electrolyte. This result clearly demonstrated four properties of the Mo nitride. (1) $\gamma\text{-Mo}_2\text{N}$ is an electrically conducting phase. (2) The high surface area Mo nitrides prepared using the
20 methods outlined above formed contiguous films. (3) The capacitance for the $\gamma\text{-Mo}_2\text{N}$ based electrodes was likely due to a surface and not a bulk charge storage process. (4) The capacitance of $200 \mu\text{F/cm}^2$ is superior to that reported for high surface area ruthenium oxide electrodes with H_2SO_4 electrolyte (Raistrick and Sherman, 1987).

Table 3. Properties of Mo Nitride Electrodes with LiClO₄ Electrolyte (1.6 Vdc)

	Sample	Charging Voltage (V)	Total Charge Stored (C)	Specific Capacitance (mF/cm ²)
5	Mo Foil (cleaned)	1.59	0.0004	0.2
	Mo-5.0-0.2-1-2A	1.58	0.068	43
	Mo-5.0-0.2-1-2B	1.60	0.034	22
	Mo-5.0-0.2-1-2C	1.59	0.072	45
	Mo-5.0-0.2-1-2D	1.59	0.127	80
10	Mo-5.0-0.2-1-2E	1.60	0.097	61
	Mo-5.0-0.2-1-2F	1.57	0.119	76
	Ti Foil (cleaned)	1.59	0.0004	0.2
	Ti-5.0-0.2-1-2	1.59	0.027	17

Table 4. Properties of Dip-Coated Mo Nitride Electrodes with H₂SO₄ Electrolyte

15	Sample	Charging Voltage (V)	Total Charge Stored (C)	Specific Capacitance (mF/cm ²)
20	Mo Foil (cleaned)	1.59	0.265	167
	Mo-5.0-0.2-1-2A	1.58	1.39	880
	Mo-5.0-0.2-1-2B	1.60	0.643	405
	Mo-5.0-0.2-1-2C	1.59	0.701	441
	Mo-5.0-0.2-1-2D	1.57	0.790	454
	Mo-5.0-0.2-1-2E	1.60	0.638	401
	Mo-5.0-0.2-1-2F	1.57	0.791	504
	Ti Foil (cleaned)	1.59	0.00007	0.04
	Ti-5.0-0.2-1-2	1.59	0.059	37

25 Molybdenum nitride electrodes were also prepared by spray deposition of paramolybdate precursors. Solutions of the paramolybdate precursor were prepared as described above for spray deposition of the oxide coatings. An ultrasonic spray system or atomized spray deposition can be used to deposit

the oxide precursor onto the substrates. The process of spray deposition and calcination were alternated to build up a multi-layer of the oxide. The substrates were heated to a temperature of about 150° C to evaporate the solvent and enhance adhesion, and then calcined as described above. The heating rates (β_1 and β_2) and capacitance results for the spray coated molybdenum nitride electrodes are shown in Table 5.

Table 5. Properties of Spray Deposited Mo Nitride Electrodes with H₂SO₄ Electrolyte

	β_1 (°C/hr)	β_2 (°C/hr)	Specific Capacitance (F/cm ²)
10	80	400	1.65 ± 0.04
	20	100	1.91 ± 0.05
	80	100	1.61 ± 0.02
	80	200	1.86 ± 0.04
	20	200	1.54 ± 0.03
15	40	400	1.86 ± 0.07
	40	100	1.11 ± 0.06

The electrode capacitances in Table 5 were obtained by coulometry as described previously. The electrolyte used was 4.5 M. sulfuric acid. Each capacitor was charged at 1.0 V with a current of 150 mA for a duration of 5 minutes to ensure charge saturation. These results demonstrate that spray deposition can also be used to produce molybdenum nitride electrodes with beneficial high surface areas.

Other new high surface area electrodes were also prepared as demonstrations of the materials and methods of this invention.

Molybdenum carbide electrodes were prepared from molybdenum nitride electrodes, prepared using the spray deposition, calcination, and nitridation methods as previously described. The nitride was converted to carbide by temperature programmed reaction with a flowing 1:3 mixture of methane/hydrogen. The temperature programmed reaction heating profiles and reactant flow rates are provided in Table 6 below. Cyclic voltammetry

was performed to determine the capacitance and stability of the carbide films in saturated aqueous KCl and LiCl electrolyte solutions. Capacitance, C , was determined by dividing the voltammetry, i , by the potential stepping rate, (dE/dt) over the plateau region of the voltammogram: $C = i/(dE/dt)$. The sample electrode served as the working electrode in a standard three electrode cyclic voltammetry configuration. The capacitance data indicate that molybdenum oxide precursors can be converted into carbide electrodes with beneficial high surface areas.

Table 6. Capacitance of Carbide Films

10	Heating Rate β ($^{\circ}\text{C}/\text{Hr}$)	Flow Rate (cc/min)	Capacitance (F/cm ²) KCl electrolyte	Capacitance (F/cm ²) LiCl electrolyte
	22	100	2.32	2.18
	22	500	1.37	1.51
	67	100	1.61	1.03
15	67	500	1.11	0.88

Tungsten/molybdenum nitride electrodes were prepared by spray deposition of paratungstate/paramolybdate solutions. Solutions of the mixed W/Mo oxide precursors were prepared by mixing equal volumes of saturated solutions of $(\text{NH}_4)_6\text{Mo}_7\text{O}_{24} \cdot 4\text{H}_2\text{O}$ and $(\text{NH}_4)_{10}\text{W}_{12}\text{O}_{41} \cdot 5\text{H}_2\text{O}$. Spray deposition, calcination, and nitridation were performed as described in previous examples. Capacitance was evaluated by cyclic voltammetry. Capacitance for these films is reported in Table 7. The capacitance data confirm that W/Mo solid oxide solutions can also be converted to beneficial high surface area electrode films. Table 7 also shows the cell loading in mg/cm^2 . Since the specific capacitance scales with loading, one may increase electrode capacitance by increasing the loading.

Vanadium nitride electrodes were prepared by spray deposition of saturated ammonium vanadate $(\text{NH}_4)\text{VO}_3$ solutions. Spray deposition, calcination, and nitridation were performed using the procedures as described for molybdenum nitride electrodes. Capacitance was evaluated by cyclic voltammetry. The capacitance for these films as reported in Table 7 confirm

that vanadium, a group Va element, can also be converted to beneficial high surface area electrode films.

Table 7.

	Electrode Material	Loading (mg/cm ²)	Capacitance (F/cm ²)
5	molybdenum nitride	13	1.9
	tungsten/ molybdenum nitride	5.5	0.3
	vanadium nitride	4.9	0.3

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We Claim:

1. A high specific surface area electrode comprising a substrate and a film layer thereon selected from the group consisting of nitrides, carbides and borides of the metals of the Groups III, IV, V, VI and VII of the Periodic Table.
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2. The high specific surface area electrode of claim 1 wherein the film layer is first applied to the substrate as an oxide of at least one of the metals from Groups III, IV, V, VI and VII of the Periodic Table and the film layer subsequently reacted with a source of nitrogen, carbon or boron.
- 10 3. The high specific surface area electrode of claim 1 wherein the metal of the film layer comprises at least two metals from Groups III, IV, V, VI and VII of the Periodic Table.
4. The high specific surface area electrode of claim 1 wherein the substrate and the film layer metal are the same.
- 15 5. The high specific surface area electrode of claim 1 wherein the film layer metal is selected from the group Mo, W or V.
6. The high specific surface area electrode of claim 1 wherein the substrate is selected from the group Mo, W or Ti.
7. The high specific surface area electrode of claim 1 wherein the
20 film layer is formed by step wise first reacting the substrate surface with an oxidizing agent followed by reacting the oxidized substrate surface with a source of nitrogen, carbon or boron.
8. The high specific surface area electrode of claim 7 wherein the oxidized surface is reacted with the source of nitrogen prior to being reacted
25 with a source of carbon or boron.
9. A method of making a high specific surface area electrode comprising the steps of: forming a metal oxide layer,
heating the metal oxide layer in a reducing environment in the presence of a source of nitrogen, carbon or boron, said heating substantially
30 uniform and continuous at a rate in the range of 0°K/hr to 500 °K/hr to a final temperature in the range of 500°K to 1300°K,
holding the heated metal oxide layer in the presence of the source of nitrogen, carbon or boron at the final temperature for a time period

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until conversion of the oxide to nitride, carbide or boride provides a specific surface area of at least $100 \text{ cm}^2/\text{cm}^2$ when measured by the BET method.

10. The method of claim 9 wherein the heated metal oxide layer is held at the final temperature until conversion of the oxide is substantially complete.

11. The method of claim 9 wherein the heated metal oxide layer is held at the final temperature until the electrical conductivity is at least 1 ohm-cm when measured by the four-point probe method.

12. The method of claim 9 wherein the first step comprises applying a molybdate, tungstate or vanadate precursor layer to a substrate and heating the precursor layer in the presence of an oxidizing environment to form the oxide layer.

13. The method of claim 9 wherein the first step comprises oxidizing the surface of a metal foil of molybdenum, tungsten or vanadium to form the oxide layer.

14. The method of claim 9 wherein the metal oxide is selected from the oxides of molybdenum, tungsten or vanadium and the source of nitrogen, carbon or boron selected from ammonia, methane or diborane.

15. An ultracapacitor comprising a first electrode produced by a method comprising the steps of:

forming a metal oxide layer,

heating the metal oxide later in a reducing environment in the presence of a source of nitrogen, carbon or boron, said heating substantially uniform and continuous at a rate in the range of 0°K/hr to 500°K/hr to a final temperature of 500°K to 1300°K ,

holding the heated metal oxide layer in the presence of the source of nitrogen, carbon or boron at the peak temperature for a time period until conversion of the oxide to nitride, carbide or boride provides a specific surface area of at least $100 \text{ cm}^2/\text{cm}^2$ when measured by the BET method,

a second electrode,

an-electrolytic solution in contact with the electrodes, and
a separator between the first and second electrodes.

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16. The ultracapacitor of claim 15 wherein the second electrode is produced by a method comprising the steps set forth for the first electrode.

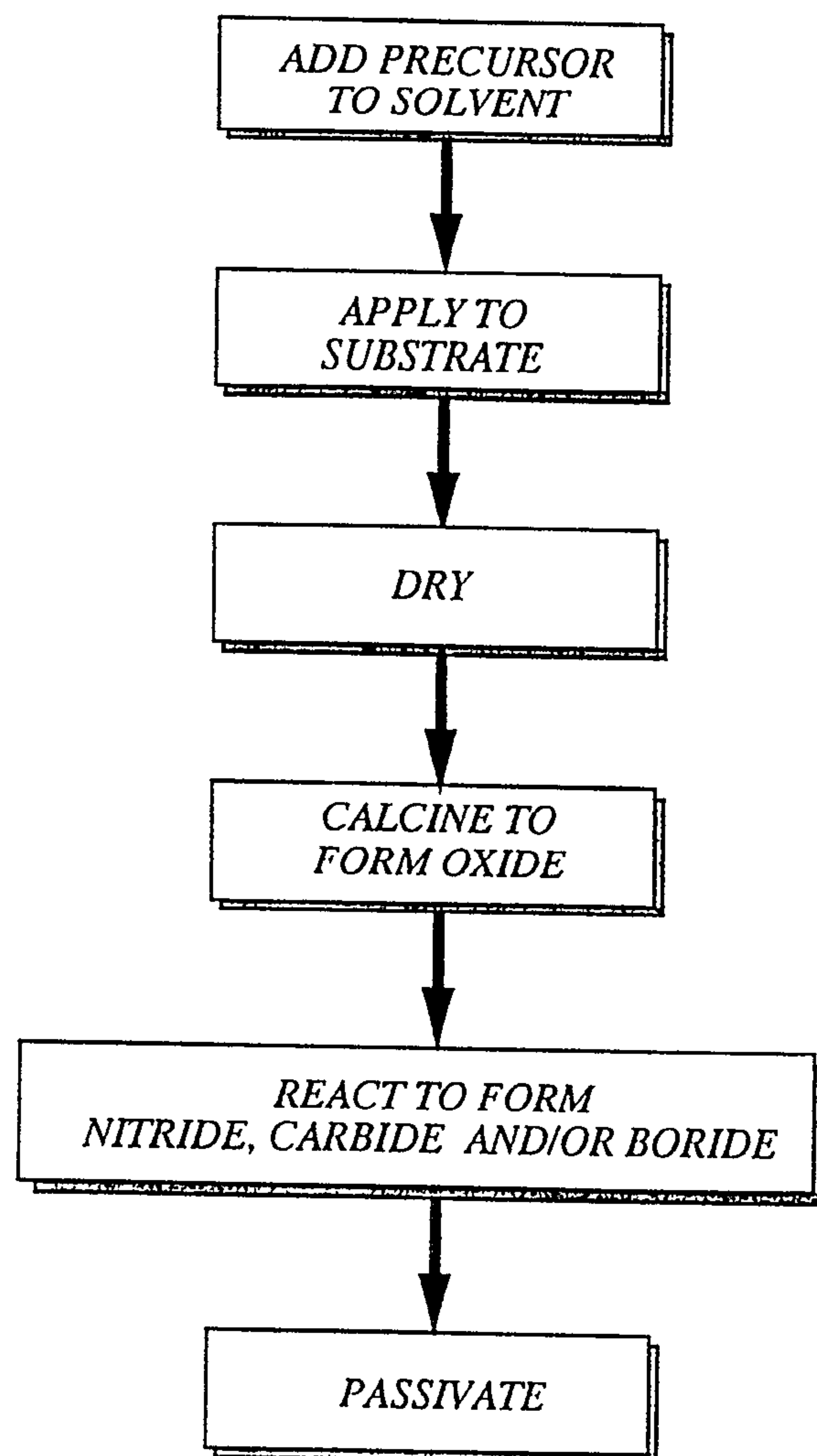
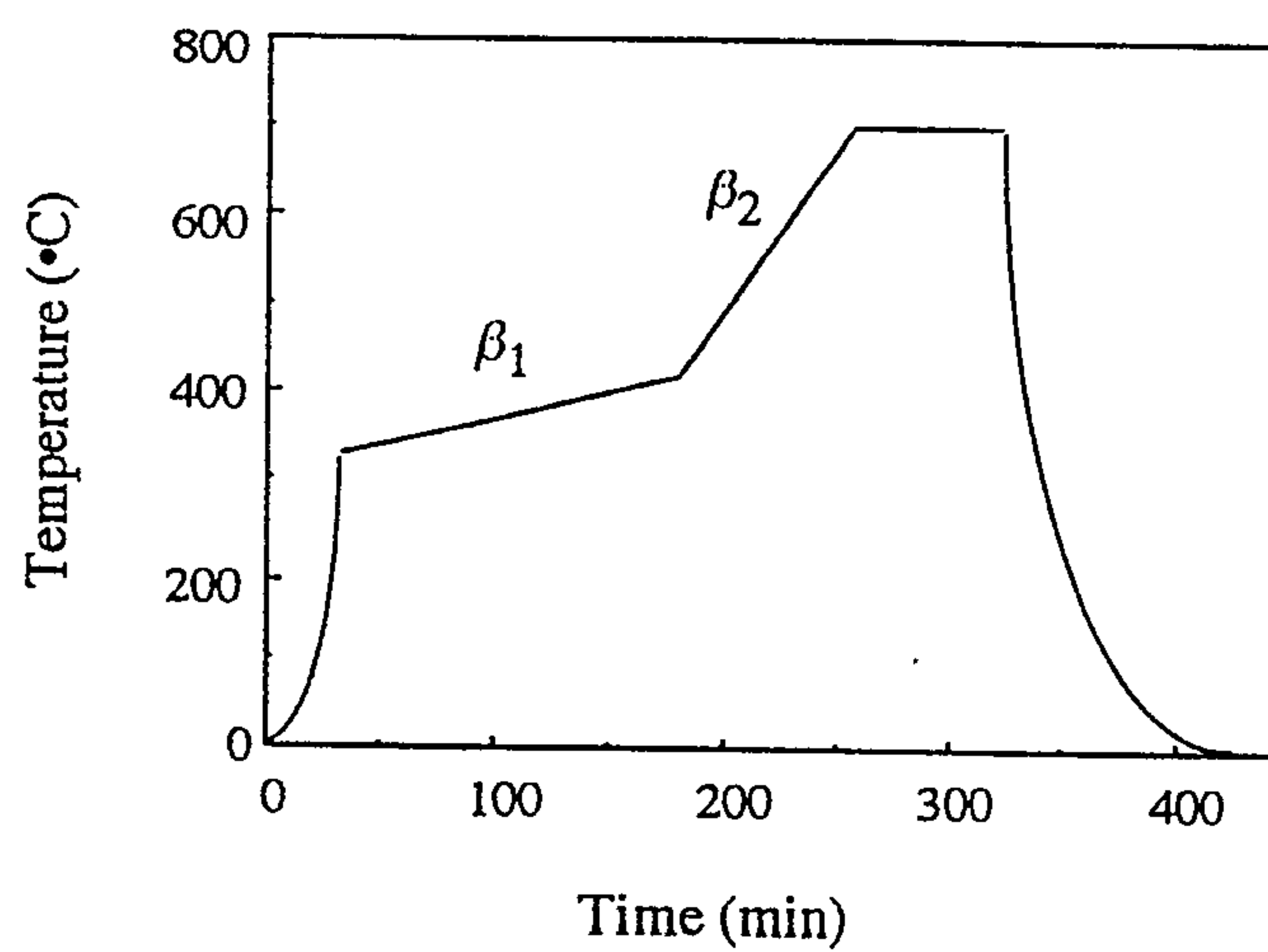
17. The ultracapacitor of claim 16 wherein the metal of the second electrode is different from the metal of the first electrode.

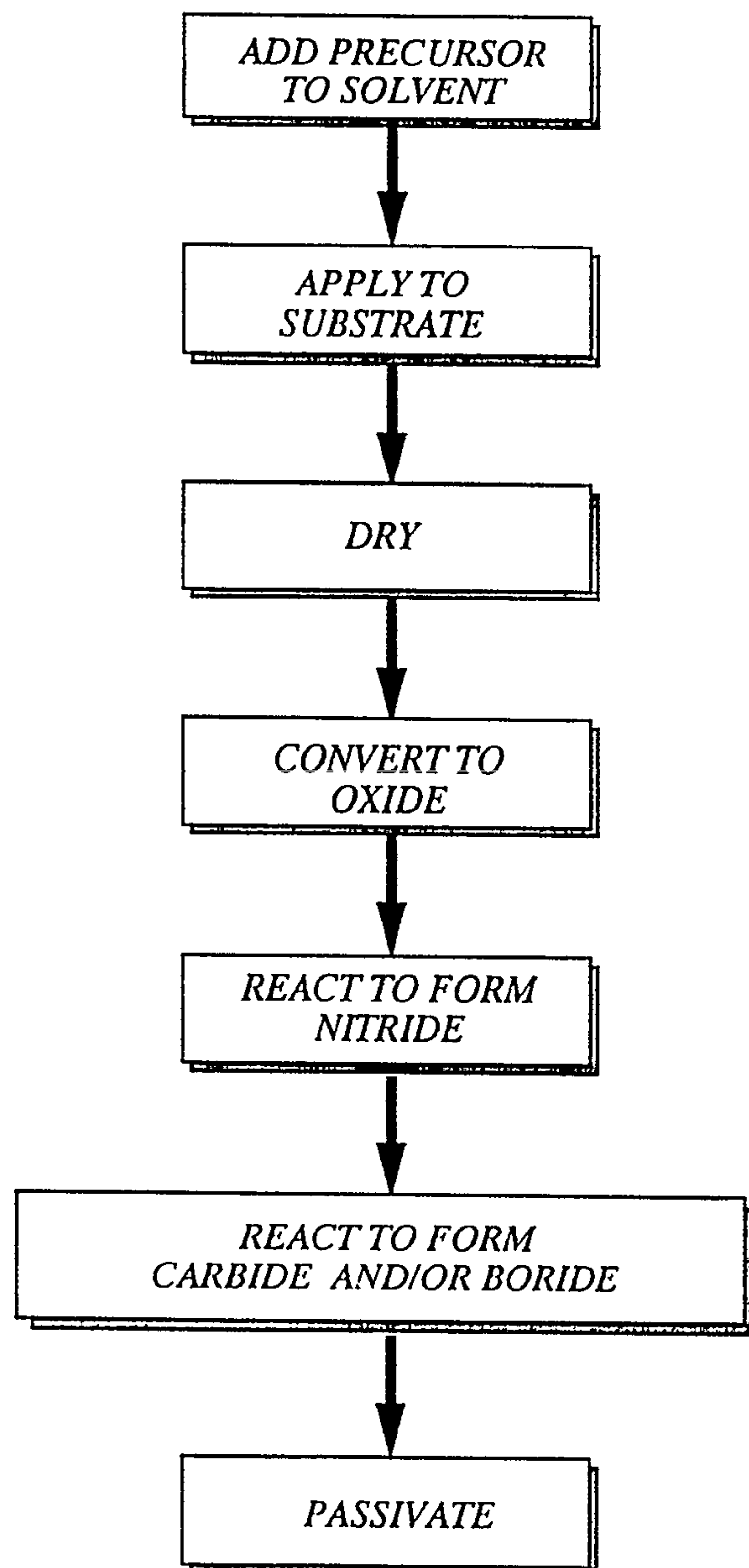
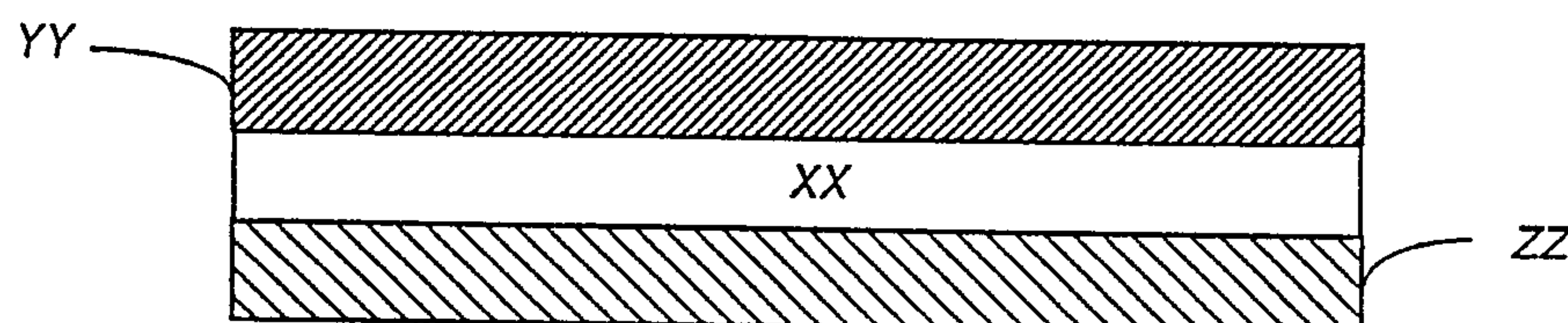
5 18. The ultracapacitor of claim 16 wherein the operating electrical potential of the second electrode is generally negative relative to the first electrode and the second electrode consists of a conductive metal oxide selected from the Group VIII metals.

10 19. The ultracapacitor of claim 15 wherein at least one electrode layer is selected from the group consisting of molybdenum nitride, molybdenum carbide, molybdenum boride, tungsten nitride, tungsten carbide, tungsten boride, vanadium nitride, vanadium carbide, vanadium boride and mixtures of two or more thereof.

15 20. The high specific surface area electrode of claim 1 wherein the film layer is first applied to the substrate as a precursor, the precursor reacted to form an oxide of at least one of the metals from Groups III, IV, V, VI and VII of the Periodic Table and the oxide film layer further subsequently reacted with a source of nitrogen, carbon or boron.

20 21. The high specific surface area electrode of claim 2 wherein the oxide film layer comprises a high specific surface area oxide prior to being subsequently reacted.

*Fig. 1**Fig. 2*

*Fig. 3**Fig. 4*

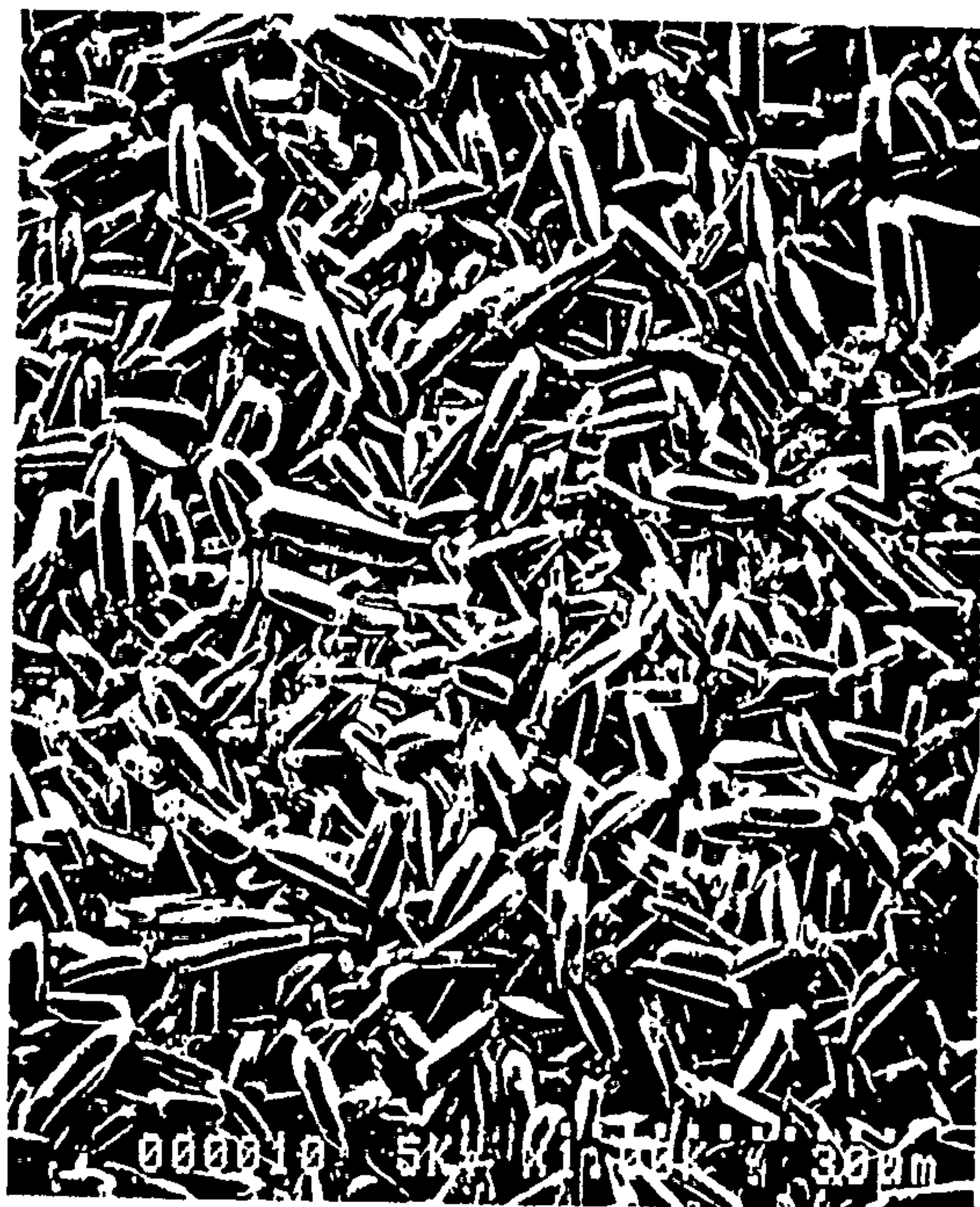


Fig. 5



Fig. 6

*ADD PRECURSOR
TO SOLVENT*



*APPLY TO
SUBSTRATE*



DRY



*CALCINE TO
FORM OXIDE*



*REACT TO FORM
NITRIDE, CARBIDE AND/OR BORIDE*



PASSIVATE